Utilization of Bourns' demonstrated expertise in technology integration, assembly processes, IC packaging technology and product launch control can result in faster time to market. Knowledgeable Bourns engineers provide a valuable, cost-effective resource across multiple environments and a broad range of applications that helps ensure enhanced functionality and compatibility from the design stage through manufacturing.

**BOURNS’ PACKAGING SOLUTIONS**

**PACKAGES AVAILABLE**

We work in close collaboration with our customers to select the optimal package for an application utilizing an abundance of options, experience and technology from Bourns.

- Single In-Line
- Dual In-Line
- COB (Chip-On-Board)
- Interposer
- System In Package
- QFN
- QFP (Quad Flat Pack)
- Mini-DIL
- TO-Cans
- Butterfly
- Hermetic Seal Custom
Flexibility is vital in electronic design. Parts change, packages shrink, and environmental requirements become more stringent. Look to Bourns Engineering & Manufacturing Services to provide:

**PRODUCT SOLUTION EXPERIENCE BY MARKET**

- **COMMUNICATIONS**
- **INDUSTRIAL**
- **MEDICAL (Low/Medium Risk*)**
- **TRANSPORTATION**
- **IoT**

**BOURNS CORE TECHNOLOGY BENEFITS**

MINIATURIZATION  
RF PERFORMANCE  
HIGH RELIABILITY  
WORLDWIDE SUPPORT  
MODULARIZATION  
THERMAL MANAGEMENT  
FASTER TIME TO MARKET  
TURNKEY SOLUTION

*Bourns® products have not been designed for and are not intended for use in “lifesaving,” “life-critical” or “life-sustaining” applications nor any other applications where failure or malfunction of the Bourns® product may result in personal injury or death. See Legal Disclaimer Notice http://www.bourns.com/docs/legal/disclaimer.pdf.

The products described herein and this document are subject to specific legal disclaimers as set forth at www.bourns.com/docs/legal/disclaimer.pdf.
PRODUCT LAUNCH CONTROL

Seamless transfer from product design and prototyping in the USA to volume production in Bourns’ China and Mexico facilities.

ENGINEERING & PROTOTYPING CENTER

Bourns, Inc.
Riverside, California
U.S. Headquarters

PRODUCTION CENTERS

Bourns (Xiamen) Ltd.
Xiamen, China

Bourns de Mexico, S. de R.L. de C.V.
Tijuana, Mexico

WORLDWIDE SALES/REPRESENTATIVE OFFICES

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Technical Assistance

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